IN THE SPECIFICATION:

Please amend the paragraph on page 5, beginning at line 7 as follows:

a plurality of strip particle portions having a composition suited to characteristics of the circuit element pattern formed on a surface of the second ceramic layer and formed as distributed on a surface or inside the layer portion.

Please amend the paragraph on page 5, beginning at line 12 as follows:

With the composite device of the laminate type, the second ceramic layer comprises the layer portion having the same composition as the first ceramic layer and serviceable as a main body, and the plurality of strip particle portions formed as distributed on the layer portion.

Accordingly, the shrinkage of the entire second ceramic layer when fired is close to the shrinkage of the first ceramic layer since the layer portion as a main body of the second ceramic layer has the same composition as the first ceramic layer. Consequently, the difference between the second ceramic layer and the first ceramic layer is smaller in shrinkage than the difference in the case where a second ceramic layer is entirely made from the composition of a strip particle portion.

Please amend the paragraph on page 6, beginning at line 13 as follows:

The plurality of strip particle portions formed as distributed on the layer portion of the second ceramic portion has a composition suited to the characteristics of the circuit element

pattern formed on the surface of the second ceramic layer, so that the circuit element pattern formed on the surface of the second ceramic layer exhibits more excellent characteristics than in the case where a pattern is formed on a surface of the first ceramic layer.

Please amend the paragraph on page 7, beginning at line 7 as follows:

Stated specifically, the layer portion is made from dielectric material, and the strip

particle portion of the second ceramic layer is made from magnetic material. According to the
specific construction, a capacitor pattern (C-pattern) is formed on a surface of the first ceramic
layer, and an inductance pattern (L-pattern) on a surface of the second ceramic layer. The
magnetized second ceramic layer renders the inductance obtained on the L-pattern greater than
the inductance on an L-pattern of the same size formed on a surface of a non-magnetized ceramic
layer.

Please amend the paragraph on page 7, beginning at line 18 as follows:

According to another specific construction, the plurality of strip particle portions formed on the second ceramic layer is distributed approximately uniformly on the surface of the layer portion. Alternatively, the plurality of strip particle portions formed on the second ceramic layer is distributed approximately uniformly inside the strip particle portions. With the specific construction, the circuit element pattern formed on the surface of the second ceramic layer obtains effect given by the strip particle portion to same extent regardless of its position formed

on the second ceramic layer. Consequently, the circuit element pattern can be freely arranged on the surface of the second ceramic layer.

Please amend the paragraph on page 10, beginning at line 10 as follows:

mixing the slurry with a plurality of strips discrete particles made from the magnetic material to obtain a slurry mixture,

Please amend the paragraph on page 10, beginning at line 14 as follows:

With the process for fabricating the composite device of the laminate type embodying the invention, the first green sheet is made from the dielectric material, and the second green sheet comprises a major portion made from the dielectric material and a portion of a plurality of strips discrete particles made from the magnetic material to obtain the composite device of the laminate type. In firing step, the difference between the first green sheet and the second green sheet is small in shrinkage, diminishing the deflection of the laminate after firing. This prevents the ceramic layers from cracking or separating from each other. Further, a plurality of strips discrete particles made from magnetic material are distributed on a surface of or inside the second green sheet, so that the second ceramic layer is magnetized. This gives sufficient characteristics to an inductor pattern provided on the surface of the second ceramic layer.

Please amend the paragraph on page 13, beginning at line 10 as follows:

As shown in FIG. 2, the composite ceramic layer 3 comprises a layer portion 31 having a same composition as the dielectric ceramic layer 2 made from dielectric ceramic material, and a plurality of strip particle portions 32 made from magnetic ceramic material. The strip particle portions 32 are approximately uniformly distributed on the surface of the layer portion 31.

Please amend the paragraph on page 14, beginning at line 11 as follows:

The strip particle portion 32 is made from the magnetic ceramic material such as Ni-Fe alloy material, Fe-Al-Si alloy material, oxide magnetic material, Ni-Zn-Cu ferrite, Ni-Zn ferrite, or hexagonal ferrite, which gives permeability to the composite ceramic layer 3. Various glasses such as borosilicate glass may be added to the material to lower the firing temperature. The Ni-Zn-Cu ferrite is not limited particularly; one of such ferrites of various compositions can be selected depending on the purpose. For example, such a ferrite is preferably 15 to 25 mole % in NiO content, 5 to 15 mole % in CuO content and 20 to 30 mole % in ZnO content. The Ni-Zn ferrite is not limited specifically, either, but one of such ferrites having various compositions can be selected according to the purpose. For example, such a ferrite is preferably 10 to 25 mole % in NiO content and 15 to 45 mole % in ZnO content.

Please amend the paragraph beginning on page 15, line 12 as follows:

FIG.S 3(a) to 3(e) show a process for preparing the composite green sheet 37 for making

the composite ceramic layer 3. With reference to FIG. 3(b), a photoresist film 7 is formed on a surface of the dielectric green sheet 25 shown in FIG. 3(a). As shown in FIG. 3 (c), a plurality of through holes 71 are provided on the photoresist film 7 by the photolithography method.

Subsequently, as shown in FIG. 3(d), a magnetic film 33 made from the magnetic ceramic material is formed on the dielectric green sheet 25 covering the photoresist film 7. Finally, the photoresist film 7 is separated and removed. As a result, formed on the surface of the dielectric green sheet 25 are a plurality of strip particle portions 32 of disk-shape which may be disc-shaped and are made from magnetic ceramic material to prepare the composite green sheet 37, as shown in FIG. 3(e). The magnetic film 33 shown in FIG. 3(d) can be formed by sputtering or plating method. The strip particle portions 32 can also be formed by printing the magnetic ceramic material according to screen printing method.

Please amend the paragraph on page 16, beginning at line 9 as follows:

FIG. 4 shows a process for preparing a composite green sheet 38 in different form from the composite green sheet 37 described. A composite slurry 34 is supplied inside a casting head 5 arranged above a carrier film 4. Magnetic particles 36 are distributed in the dielectric slurry 35 used for preparing the dielectric green sheet to obtain composite slurry 34. The carrier film 4 is transported at a predetermined speed to thereby apply the composite slurry 34 delivered from the casting head 5 onto the film 4 to a predetermined thickness. The composite slurry 34 on the film 4, thereafter, is dried to obtain the composite green sheet 38 inside which the strip particle

portions comprising the magnetic particles 36 are uniformly distributed.

Please amend the paragraph beginning on page 17, line 21 as follows:

In the composite device of the laminate type using the composite green sheets 38 shown in FIG. 4, the composite ceramic layer obtained by firing the composite green sheet 38 comprises a layer portion having a same composition as the dielectric ceramic layer made from dielectric ceramic material, and a plurality of strip particle portions made from magnetic ceramic material. The strip particle portions are approximately uniformly distributed inside the layer portion.